

## Advanced Power MOSFET

SFS9Z34

### FEATURES

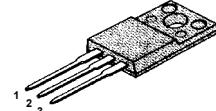
- Avalanche Rugged Technology
- Rugged Gate Oxide Technology
- Lower Input Capacitance
- Improved Gate Charge
- 175°C Operating Temperature
- Extended Safe Operating Area
- Lower Leakage Current : 10 µA (Max.) @  $V_{DS} = -60V$
- Low  $R_{DS(ON)}$  : 0.106 Ω (Typ.)

$BV_{DSS} = -60 V$

$R_{DS(on)} = 0.14 \Omega$

$I_D = -12 A$

TO-220F



1.Gate 2. Drain 3. Source

### Absolute Maximum Ratings

| Symbol         | Characteristic  | Value        | Units                |
|----------------|---|--------------|----------------------|
| $V_{DSS}$      | Drain-to-Source Voltage   | -60          | V                    |
| $I_D$          | Continuous Drain Current ( $T_C=25^\circ C$ )                           | -12          | A                    |
|                | Continuous Drain Current ( $T_C=100^\circ C$ )                          | -8.4         |                      |
| $I_{DM}$       | Drain Current-Pulsed  | ① -48        | A                    |
| $V_{GS}$       | Gate-to-Source Voltage  | $\pm 20$     | V                    |
| $E_{AS}$       | Single Pulsed Avalanche Energy  | ② 247        | mJ                   |
| $I_{AR}$       | Avalanche Current   | ① -12        | A                    |
| $E_{AR}$       | Repetitive Avalanche Energy   | ① 3.6        | mJ                   |
| $dv/dt$        | Peak Diode Recovery $dv/dt$   | ③ -5.5       | V/ns                 |
| $P_D$          | Total Power Dissipation ( $T_C=25^\circ C$ )                            | 36           | W                    |
|                | Linear Derating Factor  | 0.24         | $W/\text{ }^\circ C$ |
| $T_J, T_{STG}$ | Operating Junction and Storage Temperature Range                        | - 55 to +175 | $^\circ C$           |
|                | Maximum Lead Temp. for Soldering Purposes, 1/8" from case for 5-seconds | 300          |                      |

### Thermal Resistance

| Symbol          | Characteristic      | Typ. | Max. | Units        |
|-----------------|---------------------|------|------|--------------|
| $R_{\theta JC}$ | Junction-to-Case    | --   | 4.17 | $^\circ C/W$ |
|                 | Junction-to-Ambient | --   | 62.5 |              |

# SFS9Z34

P-CHANNEL  
POWER MOSFET

## Electrical Characteristics ( $T_C=25^\circ\text{C}$ unless otherwise specified)

| Symbol                        | Characteristic                          | Min. | Typ.  | Max. | Units                    | Test Condition   |
|-------------------------------|---|------|-------|------|--------------------------|--|
| $\text{BV}_{\text{DSS}}$      | Drain-Source Breakdown Voltage          | -60  | --    | --   | V                        | $\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=-250\mu\text{A}$                                     |
| $\Delta \text{BV}/\Delta T_J$ | Breakdown Voltage Temp. Coeff.          | --   | -0.05 | --   | $\text{V}^\circ\text{C}$ | $\text{I}_D=-250\mu\text{A}$ See Fig 7   |
| $\text{V}_{\text{GS(th)}}$    | Gate Threshold Voltage                  | -2.0 | --    | -4.0 | V                        | $\text{V}_{\text{DS}}=-5\text{V}, \text{I}_D=-250\mu\text{A}$                                    |
| $\text{I}_{\text{GSS}}$       | Gate-Source Leakage , Forward           | --   | --    | -100 | nA                       | $\text{V}_{\text{GS}}=-20\text{V}$   |
|                               | Gate-Source Leakage , Reverse           | --   | --    | 100  |                          | $\text{V}_{\text{GS}}=20\text{V}$  |
| $\text{I}_{\text{DSS}}$       | Drain-to-Source Leakage Current         | --   | --    | -10  | $\mu\text{A}$            | $\text{V}_{\text{DS}}=-60\text{V}$   |
|                               |   | --   | --    | -100 |                          | $\text{V}_{\text{DS}}=-48\text{V}, \text{T}_C=150^\circ\text{C}$                                 |
| $\text{R}_{\text{DS(on)}}$    | Static Drain-Source On-State Resistance | --   | --    | 0.14 | $\Omega$                 | $\text{V}_{\text{GS}}=-10\text{V}, \text{I}_D=-6.0\text{A}$ ④                                    |
| $\text{g}_{\text{fs}}$        | Forward Transconductance                | --   | 7.9   | --   | $\text{mS}$              | $\text{V}_{\text{DS}}=-30\text{V}, \text{I}_D=-6.0\text{A}$ ④                                    |
| $\text{C}_{\text{iss}}$       | Input Capacitance                       | --   | 890   | 1155 | pF                       | $\text{V}_{\text{GS}}=0\text{V}, \text{V}_{\text{DS}}=-25\text{V}, f=1\text{MHz}$<br>See Fig 5   |
| $\text{C}_{\text{oss}}$       | Output Capacitance                      | --   | 265   | 400  |                          |  |
| $\text{C}_{\text{rss}}$       | Reverse Transfer Capacitance            | --   | 84    | 125  |                          |  |
| $t_{\text{d(on)}}$            | Turn-On Delay Time                      | --   | 14    | 40   | ns                       | $\text{V}_{\text{DD}}=-30\text{V}, \text{I}_D=-18\text{A}, \text{R}_G=12\Omega$<br>See Fig 13 ④⑤ |
| $t_r$                         | Rise Time                               | --   | 24    | 60   |                          |  |
| $t_{\text{d(off)}}$           | Turn-Off Delay Time                     | --   | 43    | 95   |                          |  |
| $t_f$                         | Fall Time                               | --   | 28    | 65   |                          |  |
| $\text{Q}_g$                  | Total Gate Charge                       | --   | 30    | 38   | nC                       | $\text{V}_{\text{DS}}=-48\text{V}, \text{V}_{\text{GS}}=-10\text{V}, \text{I}_D=-18\text{A}$     |
| $\text{Q}_{\text{gs}}$        | Gate-Source Charge                      | --   | 5.3   | --   |                          | See Fig 6 & Fig 12 ④⑤  |
| $\text{Q}_{\text{gd}}$        | Gate-Drain("Miller") Charge             | --   | 12    | --   |                          |  |

## Source-Drain Diode Ratings and Characteristics

| Symbol                 | Characteristic            | Min. | Typ. | Max. | Units | Test Condition  |
|------------------------|---------------------------|------|------|------|-------|---|
| $\text{I}_s$           | Continuous Source Current | --   | --   | -12  | A     | Integral reverse pn-diode in the MOSFET   |
| $\text{I}_{\text{SM}}$ | Pulsed-Source Current ①   | --   | --   | -48  |       |   |
| $\text{V}_{\text{SD}}$ | Diode Forward Voltage ④   | --   | --   | -3.9 | V     | $\text{T}_J=25^\circ\text{C}, \text{I}_s=-12\text{A}, \text{V}_{\text{GS}}=0\text{V}$             |
| $\text{t}_{\text{rr}}$ | Reverse Recovery Time     | --   | 85   | --   | ns    | $\text{T}_J=25^\circ\text{C}, \text{I}_F=-18\text{A}$<br>$d\text{I}/dt=100\text{A}/\mu\text{s}$ ④ |
| $\text{Q}_{\text{rr}}$ | Reverse Recovery Charge   | --   | 0.25 | --   |       |   |

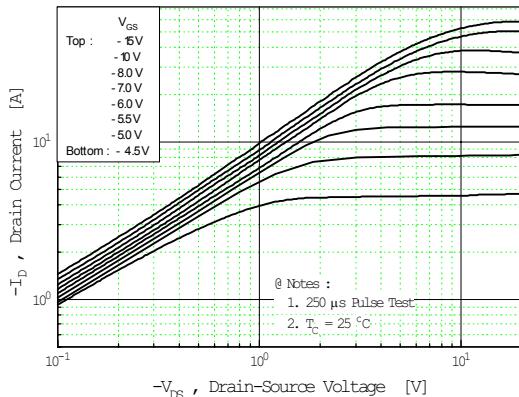
### Notes :

- ① Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature
- ②  $L=2.0\text{mH}, \text{I}_{\text{AS}}=-12\text{A}, \text{V}_{\text{DD}}=-25\text{V}, \text{R}_G=27\Omega^*$ , Starting  $\text{T}_J=25^\circ\text{C}$
- ③  $\text{I}_{\text{SD}} \leq -18\text{A}, d\text{I}/dt \leq 300\text{A}/\mu\text{s}, \text{V}_{\text{DD}} \leq \text{BV}_{\text{DSS}}$ , Starting  $\text{T}_J=25^\circ\text{C}$
- ④ Pulse Test : Pulse Width =  $250\mu\text{s}$ , Duty Cycle  $\leq 2\%$
- ⑤ Essentially Independent of Operating Temperature

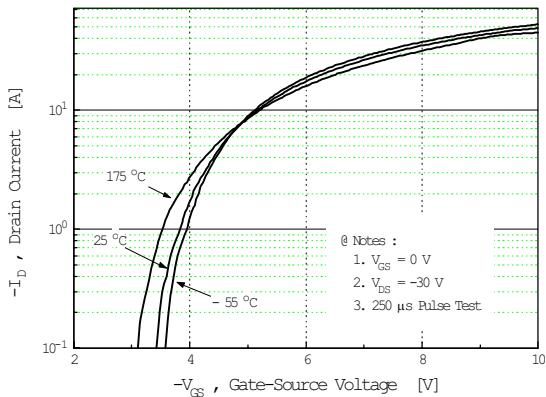
**P-CHANNEL  
POWER MOSFET**

**SFS9Z34**

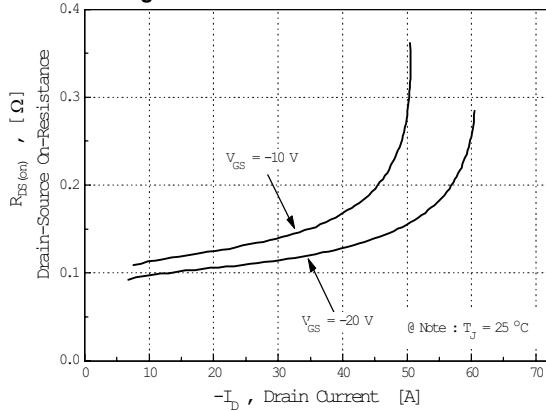
**Fig 1. Output Characteristics**



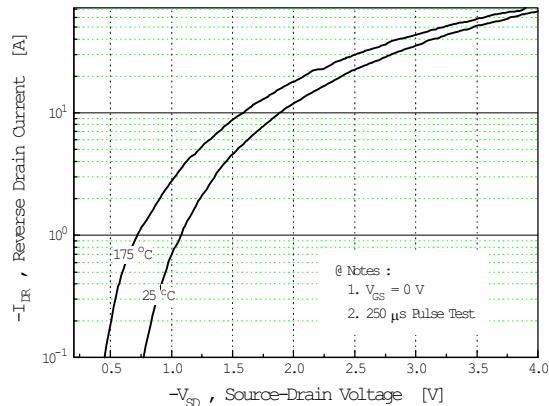
**Fig 2. Transfer Characteristics**



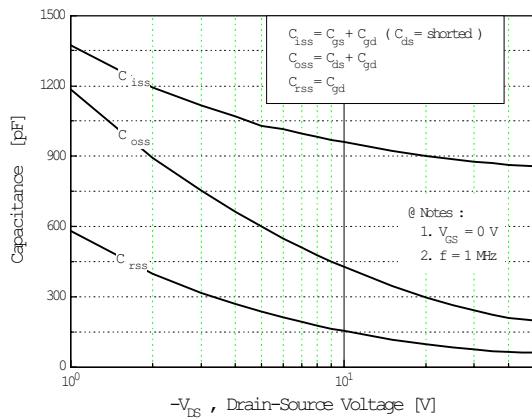
**Fig 3. On-Resistance vs. Drain Current**



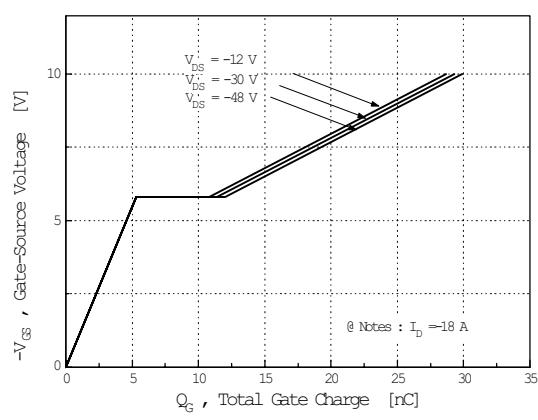
**Fig 4. Source-Drain Diode Forward Voltage**



**Fig 5. Capacitance vs. Drain-Source Voltage**



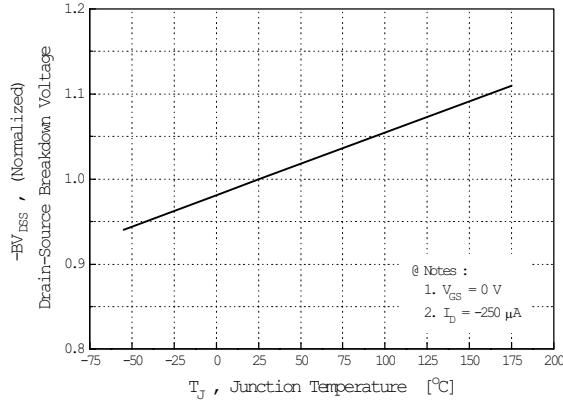
**Fig 6. Gate Charge vs. Gate-Source Voltage**



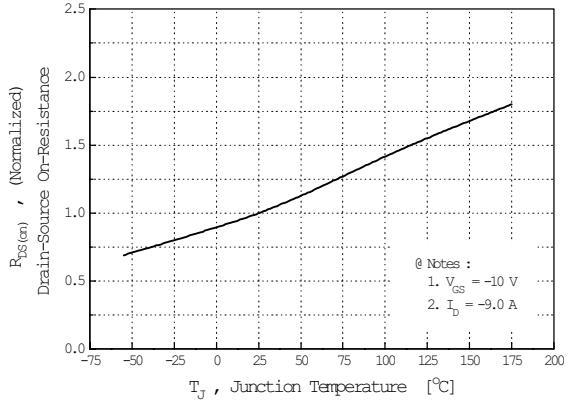
# SFS9Z34

P-CHANNEL  
POWER MOSFET

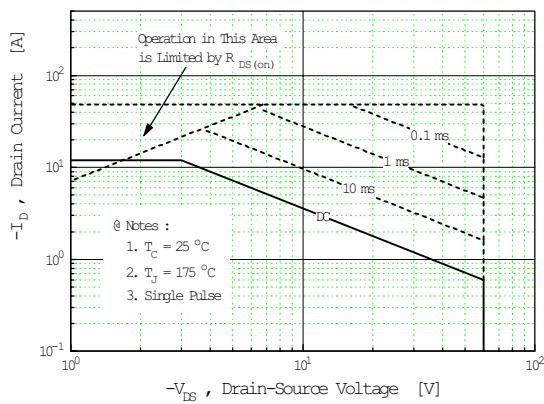
**Fig 7. Breakdown Voltage vs. Temperature**



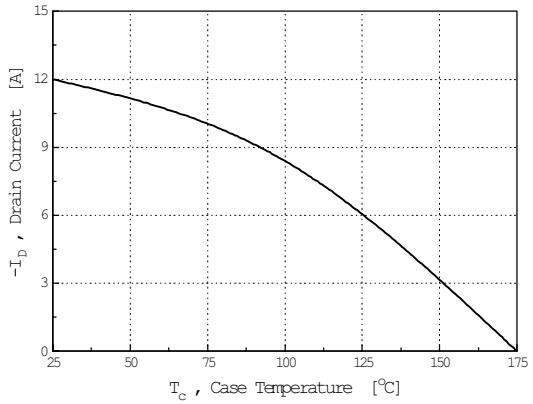
**Fig 8. On-Resistance vs. Temperature**



**Fig 9. Max. Safe Operating Area**



**Fig 10. Max. Drain Current vs. Case Temperature**



**Fig 11. Thermal Response**

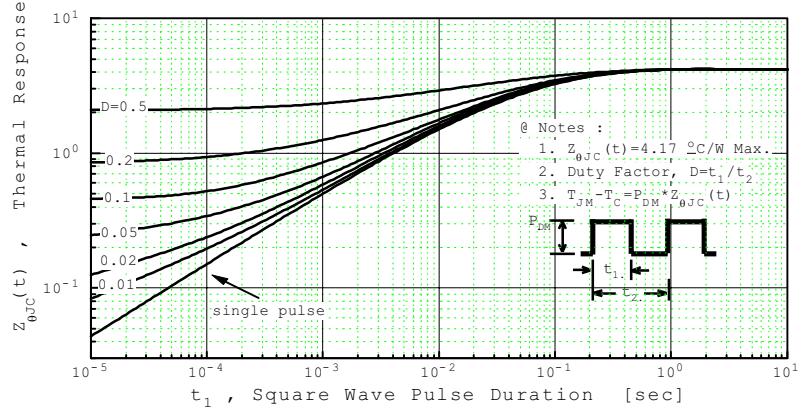


Fig 12. Gate Charge Test Circuit & Waveform

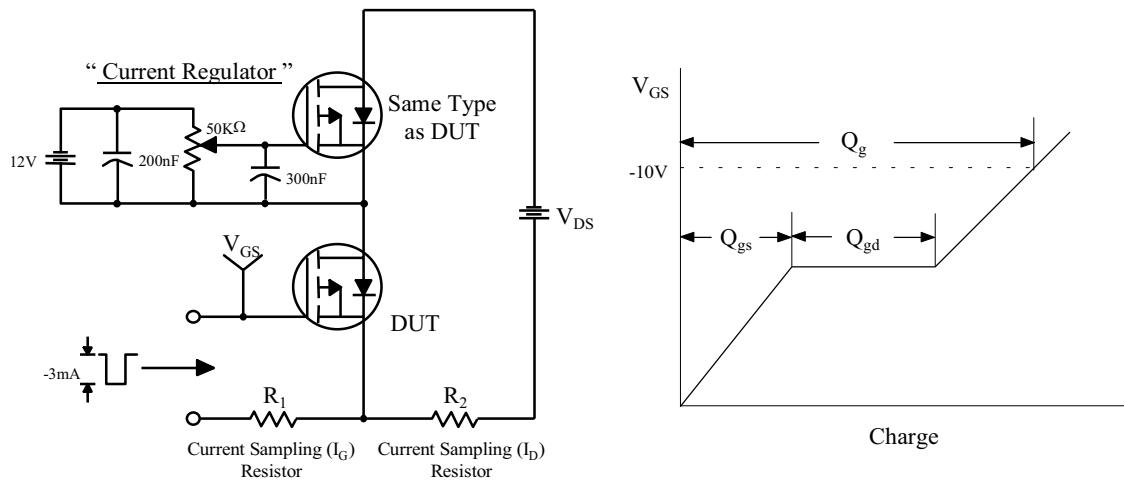


Fig 13. Resistive Switching Test Circuit & Waveforms

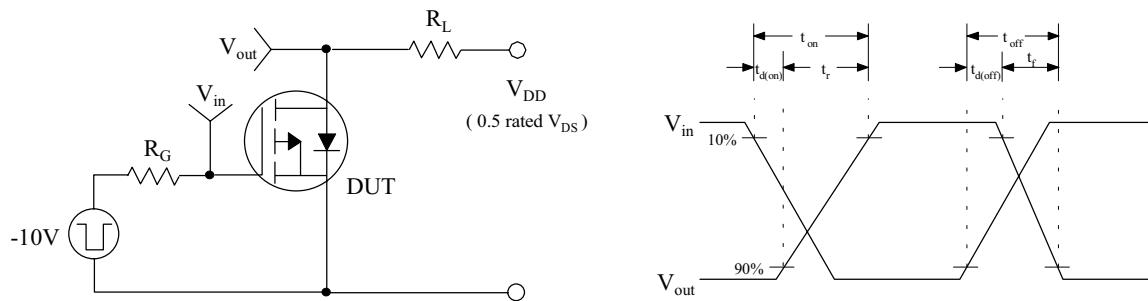


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms

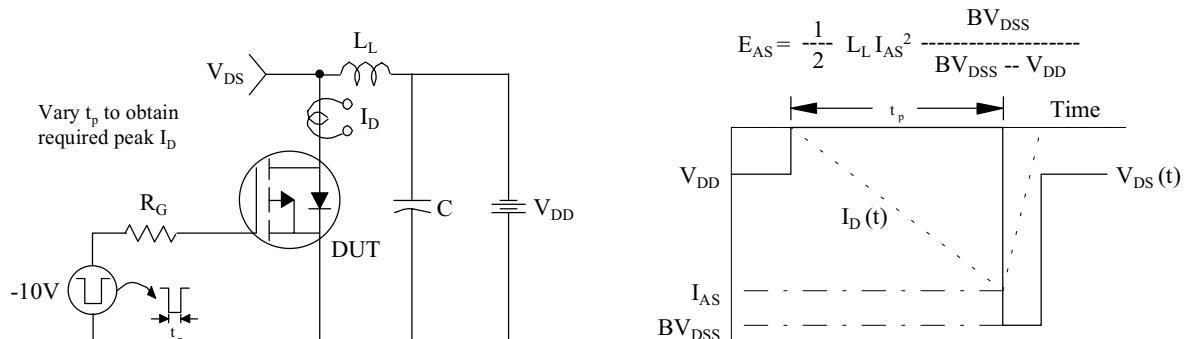


Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

